

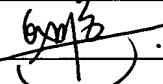
**TRANSLATION VERIFICATION STATEMENT**

I, the below-named translator, hereby declare:

- (1) That my name, mailing address and citizenship are as stated below;
- (2) That I am knowledgeable in the English language and in the Japanese language;
- (3) That I have translated U.S. Patent Application No. 10/773,245 into English, whose English text is attached hereto, and believe that said translation is an accurate and complete translation of the aforementioned Japanese patent application.

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